Tyrone Camarero Specifications

Camarero SS40012E1-436RTL

Key features

Connectivity/Storage Compute Nodes, Database Processing Appliance Platform

- Single Socket P (LGA 3647), 2nd Gen Intel[®] Xeon[®] Scalable Processors and Intel[®] Xeon[®] Scalable Processors, Support CPU TDP 70-205W, Up to 28 Cores Note : Certain high frequency optimized CPU are not supported, such as Intel Gold 6250 and 6256. Please contact Tyrone Technical Support for additional information
- Intel[®] C622 chipset
- Image and a second state of the second sta Note: 2933MHz in two DIMMs per channel can be achieved by using memory purchased from Tyrone Cascade Lake only. Contact your Tyrone sales rep for more info.
- I PCI-E 3.0 x16, 1 PCI-E 3.0 x8, 1 PCI-E 3.0 x8, 1 PCI-E 3.0 x4 (in x8)
- 1x M.2 Interface: PCI-E 3.0 x4 and SATA, Form Factor: 2280, Key: M-Key, Double Height Connector 2x 10GBase-T with Intel[®] X557
- 36 Hot-swap 3.5" SAS/SATA drive bays with SES3 (24 front + 12 rear);2 Internal fixed bay support up to
- 4x 2.5" drive bays (optional) 4 Internal fixed 2.5" drive bays 2 Hot-swap 2.5" NVMe/SATA (rear, optional)
- SAS3 via Broadcom 3008 controller
- Server remote management: IPMI 2.0/ KVM over LAN / Media over LAN
- 7 High-performance 8cm PWM fans
- 1200W Redundant Power Supplie Titanium Level (96%)

Processor/Cache

Single Socket P (LGA 3647), 2nd Gen Intel® Xeon® Scalable Processors and Intel® Xeon® Scalable Processor Processors, Support CPU TDP 70-205W, Up to 28 Cores Note : Certain high frequency optimized CPU are not supported, such as Intel Gold 6250 and 6256. Please contact Tyrone Technical Support for additional information.

Chipset

Chipset Intel® C622 chipset

System Memory

Memory Capacity	8 DIMM slots, Up to 2TB 3DS ECC DDR4-2933MHz ⁺ RDIMM/LRDIMM, Supports Intel [®] Optane [™] DCPMM Note : 2933MHz in two DIMMs per channel can be achieved by using memory purchased from Tyrone Cascade Lake only. Contact your Tyrone sales rep for more info.
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Expansion Slots

PCI-Express 1 PCI-E 3.0 x16, 1 PCI-E 3.0 x8, 1 PCI-E 3.0 x8, 1 PCI-E 3.0 x4 (in x8) 1x M.2 Interface: PCI-E 3.0 x4 and SATA, Form Factor: 2280, Key: M-Key, Double **Height Connector**

Integrated Onboard

SATA	ISATA3 (6Gbps) via C622 controller, RAID 0, 1, 5, 10 support
SAS	SAS3 (12Gbps) via Broadcom 3008 SW RAID 0, 1, 10
LAN	2 RJ45 10GBase-T LAN ports 1 RJ45 Dedicated IPMI LAN port

Add-on Options

Optical Drive

None

Front Panel

LED's Power status LED, HDD activity LED, Network activity LEDs, Universal Information (UID) LED Buttons Power On/Off button, System Reset button **Drive Bays** 36 Hot-swap 3.5"" SAS/SATA drive bays (HDD Bays 24 front + 12 rear drive bays Optional :2 Hot-swap 2.5"" NVMe/SATA drive bays (rear), 2 Internal fixed bay support up to 4x 2.5"" drive bays M.2 Interface: PCI-E 3.0 x4 and SATA, Form Factor: 2280, Key: M-Key, Double Height Connector **Power Supply**

1200W Redundant Power Supplie Titanium Level (96%)

Cooling System

7 High-performance 80mm cooling fans

Form Factor

4U Rackmount Form Factor

Dimensions

Width: 17.2"" (437mm),

Height: 7"" (178mm), Depth: 27.5"" (699mm)

Email : info@tyronesystems.com For more/current product information, visit www.tyronesystems.com

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